Nanoscale

PAPER

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Cite this: DOI: 10.1039/d5nr00694e

Received 17th February 2025, Accepted 30th April 2025 DOI: 10.1039/d5nr00694e

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Introduction

Environmental monitoring and pollution control are increasingly critical in the face of global environmental challenges. Accurate detection of nitrogen dioxide (NO_2), a major pollutant, is essential for ensuring air quality and public health.¹ Chemiresistive gas sensors are among the simplest and most effective devices for environmental monitoring, operating on the principle that the electrical resistance of a sensing material changes upon interaction with target gas molecules.^{2,3} Their straightforward design, ease of fabrication, and ability to provide real-time monitoring make them highly suitable for detecting various environmental pollutants including NO_2 . Furthermore, their compatibility with modern fabrication tech-

Low temperature inkjet-printed metal oxide sensors for sensitive and selective NO₂ detection[†]

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Advancements in gas sensor technology are critical for enhancing environmental monitoring and pollution control systems. Among the various sensor types, inkjet-printed gas sensors have emerged as a promising solution due to their low fabrication cost, scalable production, and compatibility with modern electronics. This study presents the development and characterization of inkjet-printed chemiresistive gas microsensors based on tin oxide (SnO₂) and indium oxide (In₂O₃) for the detection of nitrogen dioxide (NO₂), a major air pollutant associated with vehicular emissions and industrial activities. The sensors were fabricated on compact CMOS-compatible microchips, with integrated microheaters and electrodes measuring less than $250 \times 250 \mu$ m, enabling miniaturization and potential on-chip integration for portable sensing platforms. Metal oxide sols were deposited using a precise inkjet printing technique, and crystallization of the sensing layers was achieved via localized heating through the integrated microheaters. The SnO₂ sensor demonstrated excellent sensitivity at room temperature, detecting NO₂ concentrations as low as 10 ppb, while the In_2O_3 sensor showed optimal performance at 100 °C with comparable detection limits. Both sensors exhibited linear response behavior over a range of NO₂ concentrations, along with strong selectivity against common interfering gases. Although humidity induced minor fluctuations, both sensors maintained robust NO2 selectivity. These results underscore the potential of inkjet-printed metal oxide microsensors for developing compact, low-power, and highly sensitive gas detection systems.

> niques allows for the development of advanced, low-cost sensor arrays and integrated systems, enhancing their versatility and practical application in air quality monitoring.^{4–9}

> Semiconducting metal oxides (SMOs) are widely used in chemiresistive gas sensing due to their tunable properties. By engineering their shape and composition, SMOs can be optimized for enhanced sensing performance. Their excellent thermal stability and chemical inertness toward sensing gases help prevent long-term degradation, ensuring reliable operation. Among the most commonly employed SMOs for gas sensing are tin oxide (SnO₂) and indium oxide (In₂O₃), both of which maintain stability and resist chemical reactions in the sensing environment. These oxides, in diverse forms, including nanoparticles, nanowires, and thin films, synthesized through methods such as sol-gel, hydrothermal, and spin coating techniques, find application in NO₂ sensing.^{10–13}

> While these conventional fabrication methods are effective, they come with challenges such as long processing times, high temperatures, and material wastage, which hinder the development of scalable, cost-efficient sensors.^{14,15} These drawbacks highlight the need for alternative fabrication techniques that offer better control and efficiency in gas sensor development. Inkjet printing is a scalable, mask-free fabrication technique that enables the precise deposition of functional materials



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[†]Electronic supplementary information (ESI) available. See DOI: https://doi.org/ 10.1039/d5nr00694e

Paper

with minimal material waste. Compared to conventional methods such as sol-gel processing, hydrothermal synthesis, and spin-coating, inkjet printing offers advantages including low-cost batch fabrication, direct patterning on flexible or CMOS-compatible substrates, and reduced process complexity. These features make it a promising technique for microsensor fabrication and integration into smart sensing platforms. Moreover, inkjet printing offers a clean, efficient, and highly adaptable method.^{16,17} Utilizing cartridges with micrometersized holes, this method ensures precision printing with droplet sizes in the picolitre range.^{17–19} Its versatility enables the printing of a wide range of materials, including metal oxide sols, nanoparticle suspensions, polymers, and more, making it ideal for application in biosensors, supercapacitors, solar cells, and various other advanced technologies.^{20–22}

In recent years, inkjet-printed gas sensors have gained considerable attention due to their potential to significantly reduce production costs and simplify the fabrication process. This technique enables the direct deposition of metal oxide inks onto a variety of substrates at room temperature, offering a scalable and versatile approach. As a result, inkjet-printed gas sensors are emerging as a promising technology for revolutionizing real-time air quality monitoring. However, most studies have focused on polymer-based and graphene-based sensors, which operate at room temperature but exhibit limited sensitivity to NO2.23-25 Devabharathi et al. explored inkjet-printed SnO2 sol-based NO2 sensors, which required post-print annealing to enhance their structural and electrical properties.¹⁸ Their research demonstrated that inkjet printing could produce uniform mesoporous SnO₂ films with good sensitivity to NO₂, with the mesoporous structure playing a key role in improving gas adsorption and sensor performance. However, a significant drawback of this approach is the relatively high operating temperature required, which limits the practical application of these sensors in ambient or roomtemperature environments. In contrast, Ogbeide et al. developed a room-temperature NO₂ sensor using a composite of reduced graphene oxide (rGO) and copper cobalt oxide (CuCoO_x), eliminating the need for post-print annealing.²⁶ The use of a composite suspension ink allowed for a more straightforward fabrication process and enhanced the sensor's performance at ambient temperatures. However, while the sensor exhibited improved ease of fabrication, it still showed a lower response to NO2 and was prone to cross-sensitivity to ammonia, a common issue in gas sensors that detect multiple compounds. These limitations suggest that while the roomtemperature operation is beneficial, it still requires optimization in terms of sensitivity and selectivity.

Moreover, most reported work on inkjet-printed gas sensors has focused on larger substrates, typically intended for broader environmental monitoring applications. The fabrication of inkjet-printed NO_2 microsensors, which would allow for compact and portable devices with microchip integration, remains largely unexplored. In this work, we aim to address this gap by exploring the potential of inkjet printing for fabricating metal oxide microsensors on microchips with integrated microheaters. This approach combines the high sensitivity of metal oxide sensors with the precision and flexibility of inkjet printing, offering a promising route for efficient, real-time NO_2 detection. We present two microsensors: a room-temperature SnO_2 -based sensor and a low-temperature In_2O_3 -based sensor, both fabricated *via* inkjet printing using metal oxide sols. These sensors exhibit excellent sensitivity and selectivity at their respective optimal operating temperatures, paving the way for more efficient gas sensors.

Experimental

Preparation of ink

The metal oxide sol used as ink for inkjet printing was prepared using indium acetate (99.9% purity, Sigma-Aldrich), tin (II) 2-ethylhexanoate (99% purity, Sigma-Aldrich), and ethanolamine (99% purity, Sigma-Aldrich). The process began by dissolving 0.05 moles of indium acetate or tin(II) 2-ethylhexanoate in 40 mL of ethanol (99% purity, Sigma-Aldrich). Once fully dissolved, 3 mL of ethanolamine was gradually added dropwise as a stabilizing agent to ensure uniform precursor dispersion. The solution was continuously stirred at 60 °C for 4 hours, facilitating the reaction and forming a stable sol.

To ensure reliable inkjet printing, the sol underwent a purification process. It was aged for seven days to enhance ink dispersion and stability. After aging, precipitates were removed to improve ink homogeneity. For further refinement, the sol was passed through a 0.22 μ m membrane filter to eliminate any residual particulates. This filtration step was crucial for achieving high ink purity, preventing nozzle clogging, and enabling precise sensor fabrication.

Sensor fabrication

Fig. 1 illustrates the CMOS microchip and the various components and processes involved in fabricating the final sensor. Specifically, Fig. 1(a) shows the different layers of the CMOS substrate. The CMOS microheater is designed and fabricated using the TSMC 0.18 µm mixed-signal RF CMOS 1P6M process (one poly and six metals), in combination with the NARLabs TSRI (National Applied Research Laboratories, Taiwan Semiconductor Research Institute) backside silicon etch postprocess. By etching the silicon backside, a cavity filled with air (which has a low thermal conductivity of 0.026 W $(m K)^{-1}$) is created. This air-filled cavity acts as a thermal insulator, reducing heat conduction away from the heater.²⁷ Consequently, the heater can achieve and maintain higher temperatures, which is crucial for precise thermal management and improves the overall energy efficiency and performance of the device. The heater's main structure features a parallel sandwich configuration consisting of metal 4 (AlCu), via 4 bar (tungsten), and metal 5 (AlCu). The interdigitated electrode (IDE) is constructed using metal 6, which is the top layer on the chip with a thickness of 2 µm, for temperature monitoring.

Fig. 1(b) shows the DMP 2831 printer used in this study. The printer is equipped with a 16-head cartridge, each head



Sensor Assembly

Fig. 1 (a) Various layers in the CMOS substrate, (b) the inkjet printing process, (c) the optical image of the substrate and (d) the final sensor assembly.

featuring a 30 μ m nozzle diameter and a print volume of 10 picolitres. In this research, a single head was employed to ensure precise deposition of the sensing material onto a 250 μ m × 250 μ m surface over the IDE. After printing, the material was dried at 60 °C for one hour to ensure optimal adhesion. The printing process was repeated twice to achieve uniform and comprehensive coverage. An optical image of the CMOS chips is shown in Fig. 1(c), and a cross-sectional diagram of the microchip is provided in Fig. S1.† Finally, the chip was wire-bonded onto a printed circuit board (PCB), forming the final sensor assembly as shown in Fig. 1(d).

Fig. 1(b) shows the DMP 2831 printer used in this study. The printer is equipped with a 16-head cartridge, each head featuring a 30 μ m nozzle diameter and a print volume of 10 picolitres. In this research, a single head was employed to ensure precise deposition of the sensing material onto a 250 μ m × 250 μ m surface over the IDE. After printing, the material was dried at 60 °C for one hour to ensure optimal adhesion. The printing process was repeated twice to achieve uniform and comprehensive coverage. An optical image of the CMOS chips is shown in Fig. 1(c), and a cross-sectional diagram of the microchip is provided in Fig. S1.† Finally, the chip was wire-bonded onto a printed circuit board (PCB), forming the final sensor assembly as shown in Fig. 1(d).

The temperature distribution profile of the sensor, illustrated in Fig. 2(a), demonstrates a uniform pattern, ensuring

Paper



Fig. 2 (a) The temperature distribution on the substrate surface and (b) the correlation between heater current and heater temperature.

consistent performance and reliable sensing under various operating conditions. A uniform temperature profile is crucial for minimizing variations in sensor response, which enhances both measurement accuracy and repeatability. The relationship between heater current and temperature, shown in Fig. 2(b), helps in selecting the optimal heater current for operation. Table 1 presents the approximate temperatures, derived from the graph, which were used in the sensing experiments.

Material characterization

The phase formation and crystal structure of the sensing material were investigated using X-ray diffraction (XRD, Bruker D2 PHASER with Cu K α radiation, 30 kV, 10 mA) and compared with existing crystallographic data for oxide materials. The surface microstructure of the printed In₂O₃ was analyzed using a scanning electron microscope (FESEM, JEOL 6500F) and a high-resolution transmission electron microscope (HRTEM, JEOL JEM-F200). Chemical information was obtained through X-ray photoelectron spectroscopy (XPS, Ulvac-PHI PHI 1600).

Sensing measurements

An air compressor supplied air at 25 $^{\rm o}{\rm C}$ with a relative humidity of 25%. Various target gases were introduced through gas cylin-

 Table 1
 Heater currents and the corresponding approximate temperatures used in the experiments

Heater current (mA)	Temperature (°C)		
0	0		
150	50		
300	100		
350	125		
400	150		

ders, each containing a mixture of dry air and the respective gas. The concentrations of the gases used in the experiments were 1 ppm for NO₂, 30 ppm for SO₂, 100 ppm for CO, 50 ppm for NH₃, and 10 000 ppm for CO₂. Mass flow controllers (MFCs) were employed to precisely regulate the flow rates of both air and the target gases, allowing for the adjustment of gas concentrations and the maintenance of desired ppm levels. The total flow rate was kept constant at 400 sccm. Relative humidity was controlled by adjusting the height of a water column to achieve the desired levels. Data acquisition was carried out using a National Instruments USB-6009 DAQ system, and data collection was managed using LabVIEW software. The acquired data were subsequently analyzed to assess the performance of the sensor. The response *S* was calculated using the stable resistance in air (R_a) and the stable resistance in the test gas (R_r):

$$S = (R_g - R_a)/R_a \times 100 \tag{1}$$

The response and recovery times were estimated based on the time required for the sensor resistance to reach 90% of its maximum change upon gas introduction (response) and removal (recovery).

Results and discussion

To evaluate the formation of crystalline metal oxides, X-ray diffraction (XRD) analysis was conducted. Fig. 3(a) displays the XRD pattern, showcasing distinct broader peaks at specific 2θ values that are characteristic of the material's crystalline structure. For In₂O₃, prominent diffraction peaks are observed at the (211), (222), (400), (420), (431), and (440) planes, which correspond to the standard diffraction patterns for cubic In₂O₃.^{13,28} The absence of additional peaks confirms the successful synthesis of phase-pure In₂O₃ without significant



Fig. 3 (a) X-ray diffraction pattern of the printed sensor, and FE-SEM images of the printed (b) In₂O₃ and (c) SnO₂ sensors.

impurities or secondary phases. Similarly, the XRD pattern of SnO_2 exhibits broader peaks compared to In_2O_3 , with characteristic reflections at the (110), (101), (200), and (211) planes, corresponding to tetragonal SnO_2 .^{29,30} The peak broadening is attributed to the low crystallization temperature employed for sensor fabrication.²⁹

The scanning electron microscopy (SEM) images in Fig. 3(b) and (c) provide detailed insight into the surface morphology of the as-printed In₂O₃ and SnO₂ sensors, respectively. The SEM images reveal a textured surface composed of welldefined nanoparticles or grains, with diameters of approximately 10-15 nm for In₂O₃ and 15-20 nm for SnO₂. These nanoparticles are agglomerated into a uniform and continuous film, which is critical for achieving consistent gas adsorption and desorption, thereby ensuring stable and reliable sensor performance. Both In₂O₃ and SnO₂ films exhibit mesoporous structures, with a higher pore distribution observed in SnO_2 compared to In_2O_3 . The presence of mesopores plays a significant role in facilitating gas diffusion, improving the sensor's response time and sensitivity. Post-image analysis using ImageJ software was performed to quantify the surface pore coverage of the printed films (Fig. S2[†]), revealing values of 36% for SnO₂ and 23% for In₂O₃. This increased porosity enhances the overall surface area of the sensor, allowing for better gas interaction and improved sensing capabilities.18,31,32

The high-resolution transmission electron microscopy (HRTEM) image in Fig. 4 provides a clear understanding of the crystallinity and grain size of the printed metal oxides. The HRTEM image of printed In_2O_3 (Fig. 4(a)) displays well-defined lattice fringes with a spacing of 0.291 nm, corres-

ponding to the (222) plane of In₂O₃, confirming its crystalline nature.²⁸ The inset TEM image, with a scale bar of 50 nm, illustrates the overall shape and agglomeration behavior of the nanoparticles. These nanoparticles exhibit a uniform size of approximately 10-15 nm with a consistent shape, indicating precise control over the synthesis process. Similarly, Fig. 4(b) presents the HRTEM image of printed SnO2, where distinct lattice fringes with a spacing of 0.331 nm are observed, corresponding to the (110) plane of SnO₂.²⁹ The inset image reveals uniformly distributed SnO2 nanoparticles with an average size of 15-20 nm. These observations confirm the crystalline nature of the printed metal oxides, despite the broader peaks observed in the XRD analysis. Furthermore, the particle sizes obtained from HRTEM closely match those observed in the SEM analysis, reinforcing the consistency and reliability of the fabrication process.

X-ray photoelectron spectroscopy (XPS) provides an indepth analysis of the chemical states of oxygen and metal in printed metal oxides, offering crucial insights into their role in gas sensing. Fig. 5(a) presents the O 1s core-level spectrum of In₂O₃, deconvoluted into three distinct peaks at 529.25 eV, 530.5 eV, and 532.1 eV.^{12,13} These peaks correspond to lattice oxygen, non-stoichiometric oxygen (including oxygen vacancies and related defects), and surface-adsorbed hydroxyl groups, respectively.⁴ The A_v/A_L ratio, representing the proportion of non-stoichiometric to lattice oxygen, is estimated to be 0.25 for the printed indium oxide film. The In 3d spectrum (Fig. 5b) reveals well-defined peaks at 443.9 eV and 451.4 eV, corresponding to the In 3d_{5/2} and In 3d_{3/2} levels, respectively.^{33,34} These binding energies confirm the oxidized state of indium, further supporting its role in the sensor's functionality.



Fig. 4 HR-TEM images of printed (a) SnO₂ and (b) In₂O₃.



Fig. 5 XPS spectrum of printed (a ϑ b) In₂O₃ and (c ϑ d) SnO₂ sensors.

Similarly, Fig. 5(c) depicts the O 1s spectrum of printed SnO_2 , where the deconvoluted peaks at 530.2 eV, 531.6 eV, and 532.3 eV correspond to metal-oxygen bonds, non-stoichiometric oxygen, and surface-adsorbed hydroxyl groups,

respectively.^{29,30} The higher A_v/A_L ratio of 0.37 for SnO₂ suggests a greater density of oxygen defects compared to In₂O₃, which can enhance gas adsorption and reaction sites. Fig. 5(d) presents the Sn 3d spectrum, showing distinct peaks

at 495 eV and 483.9 eV, assigned to Sn $3d_{3/2}$ and Sn $3d_{5/2}$, respectively.^{31,35} These values confirm the oxidized state of tin, consistent with its expected chemical composition. Overall, the XPS analysis confirms the presence of critical chemical states and highlights the active sites essential for gas interactions. The observed differences in oxygen defect density between In_2O_3 and SnO_2 suggest variations in their gassensing performance.

The sensing characteristics of the inkjet-printed In_2O_3 microsensor for detecting NO_2 are depicted in Fig. 6. Fig. 6(a) illustrates the sensor's response to 500 ppb NO_2 as a function of temperature. The response increases with temperature, peaking at around 100 °C, followed by a decline. This trend suggests that the sensor's optimal operating temperature for NO_2 detection is 100 °C. A noticeable sensor response of ~25% can be observed for 500 ppb of NO_2 at room temperature (25 °C). In Fig. 6(b), the sensor exhibits a significant change in resistance, with a clear, distinct response to each concentration from 500 ppb to 10 ppb, demonstrating high sensitivity and a large dynamic range. The percentage changes in resistance, from 99% at 500 ppb to ~4% at 10 ppb, indicate robust sensor performance across different concentration levels. The sensor shows measurable resistance changes even at 10 ppb, highlighting its capability to detect trace levels of NO₂. The response magnitude decreases as the concentration decreases, but the sensor still maintains a noticeable signal, proving its high sensitivity.

The inset in Fig. 6(b) provides a calibration curve plotting sensor response against NO₂ concentration on a logarithmic scale. The linear relationship with an adjusted R^2 value of 0.99 indicates excellent linearity and reliability of the sensor for quantifying NO₂ concentrations. This linearity is crucial for accurate and reproducible measurements in practical applications. The resistance transient of the In₂O₃ sensor is depicted in Fig. 6(c), and the response and recovery times were determined to be approximately 240 s and 580 s, respectively. Moving along, Fig. 6(d) explores the sensor's performance under different relative humidity (RH) levels at a constant NO₂ concentration of 500 ppb. The sensor maintains high sensitivity across all tested RH levels (25% to 92%), although the absolute response magnitude varies slightly. Furthermore, Fig. 6(e) assesses the sensor's selectivity by comparing its



Fig. 6 (a) Sensing performance of the inkjet-printed In_2O_3 microsensor at different temperatures for 500 ppb of NO_2 , (b) concentration variation study for NO_2 at 100 °C (sensitivity curve in the inset), (c) the resistance transient for 500 ppb NO_2 at 100 °C, (d) the effect of relative humidity on the sensing performance, and (e) selectivity against other gases at 100 °C.

response to NO₂ against other gases (NH₃, CO₂, CO, and SO₂). The printed In_2O_3 sensor shows a significantly higher response to NO₂ compared to other gases, confirming its high selectivity.

Fig. 7 illustrates the sensing characteristics of the printed SnO_2 microsensor for NO_2 detection. Fig. 7(a) depicts the sensor's response to 500 ppb NO_2 at various operating temperatures. The SnO_2 -based sensor exhibits its highest response at room temperature (25 °C), with a response of approximately 652%. As the temperature increases, the response gradually decreases, indicating that lower temperatures favor NO_2 detection for this sensor. This trend suggests that the sensor operates most effectively under ambient conditions, making it wellsuited for low-temperature applications. The decline in response at higher temperatures could be attributed to reduced gas adsorption or increased desorption from the sensor surface, which diminishes sensitivity.

Fig. 7(b) showcases the sensor's response to NO_2 at different concentrations, ranging from 10 ppb to 500 ppb levels. A clear resistance change is observed for each concentration, demonstrating high sensitivity and a broad dynamic range. The percentage response increases with gas concen-

tration, with a significant 652% response at 500 ppb NO₂. The sensor maintains a noticeable response even at lower concentrations, confirming its capability to detect trace levels of NO₂. The inset in Fig. 7(b) presents a calibration curve that plots sensor response against NO₂ concentration, revealing a strong linear correlation with an adjusted R^2 value of 0.99. This high linearity ensures accurate and reproducible measurements, which is crucial for gas sensing applications.

Furthermore, the SnO₂ sensor exhibited a response time of about 80 s and a recovery time of approximately 540 s as shown in Fig. 7(c). Fig. 7(d) examines the sensor's behavior under varying relative humidity levels while being exposed to a constant NO₂ concentration of 500 ppb. The sensor response remains stable across different RH levels (25% to 90%), although some variations are observed. The response values recorded at different RH levels include 603% at 40% RH, 611% at 60% RH, and 628% at 90% RH. Despite these variations, the sensor demonstrates reliable performance in humid environments, making it suitable for practical applications. Finally, Fig. 7(e) evaluates the selectivity of the sensor by comparing its response to NO₂ against other gases such as CO₂, NH₃, SO₂ and CO. The sensor exhibits a significantly stronger response



Fig. 7 (a) Sensing performance of the inkjet-printed SnO_2 microsensor at different temperatures for 500 ppb of NO_2 , (b) concentration variation study for NO_2 at room temperature (sensitivity curve in the inset), (c) the resistance transient for 500 ppb NO_2 at 25 °C, (d) the effect of relative humidity on the sensing performance, and (e) selectivity against other gases at 100 °C.

to NO_2 than to other interfering gases, confirming high selectivity. The minimal response to other gases suggests that the sensor is well-suited for NO_2 detection with minimal cross-sensitivity.

The sensing data clearly indicate that the printed SnO_2 sensor outperforms the printed In_2O_3 sensor. Therefore, its stability was evaluated over a one-month period. Fig. 8 presents the sensing data of the printed SnO_2 microsensor at various intervals, demonstrating consistent performance with minimal degradation. Even after a month, the sensor maintains a stable response, highlighting its robustness and reliability for long-term applications.

The gas sensing mechanism is illustrated in Fig. S3.[†] When metal oxide is exposed to the atmosphere, oxygen molecules adsorb onto its surface. This adsorption process involves the transfer of electrons from the metal oxide lattice to the oxygen molecules. As oxygen molecules accept these electrons, they create an electron-deficient region on the sensor's surface, forming a depletion layer that increases the sensor's resistance.¹⁰ At lower temperatures, such as those in the current study, the most common oxygen anions on the metal oxide surface are O_2^{-36} In the presence of NO₂, the gas molecules adsorb onto the sensor surface and undergo specific



Fig. 8 Stability of a printed SnO_2 microsensor over the period of a month.

Sl. no	Material	Temperature (°C)	Response			
			(%)	$\left(\frac{R_{\rm g}}{R_{\rm a}}\right)$	Concentration (ppb)	Ref.
1	Inkjet-printed SnO ₂	175	_	11 507	5000	18
2	Inkjet-printed rGO/CuCoOr	RT	~ 70	_	1000	26
3	SnSe nanoflakes	RT	_	12.12	1000	48
4	$SnS_2/Mo_{4/3}B_2$	RT	_	4.82	1000	49
5	Mo ₂ CT ₂	RT	65	_	10 000	43
6	Inkjet-printed SnO ₂	RT	~665	7.6	500	This work
			~8	_	10	

Table 2 Recent literature on NO₂ sensing

reactions,^{37,38} further affecting the sensor's electrical properties:

$$NO_{2(gas)} + e^- \leftrightarrow \ NO_{2(ads)}^- \eqno(2)$$

$$2NO_{2(gas)} + O_{2(ads)}^{-}2e^{-} \leftrightarrow 2NO_{2(ads)}^{-}O_{(ads)}^{-}$$

$$(3)$$

With the adsorption of NO_2 molecules onto the surface, the depletion region on the sensor expands further because NO_2 accepts electrons from the metal oxide conduction band, which increases the sensor's resistance.³⁹ The difference in resistance between air and NO_2 environments is measured to quantify the sensor response.

In the present study, the printed SnO₂ sensor demonstrated excellent sensitivity at room temperature, along with a faster response time and higher overall responsiveness, attributed to its greater surface porosity and oxygen vacancy concentration, as confirmed by SEM and XPS analyses.4,29,40,41 These characteristics make it particularly suitable for low-power, ambientcondition applications. In contrast, the In₂O₃ sensor performed optimally at elevated temperatures (100 °C) and showed more stable behavior under humid conditions, making it a promising candidate for applications where temperature control is feasible and humidity resistance is critical. These combined factors contribute to the superior gas sensing performance of printed SnO2 over printed In2O3 at room temperature. Although the recovery times of the sensors may seem relatively slow, such behavior is typical of metal oxide gas sensors operating at low sensing temperatures.35,42,43 To improve the response and recovery characteristics, several strategies can be considered. These include surface functionalization with catalytic additives to enhance surface reactions and nanostructuring of the sensing material to increase the surface-to-volume ratio, thereby facilitating faster gas diffusion and adsorption/desorption kinetics.13,29,44

Both sensors exhibit good sensitivity across varying relative humidity (RH) levels. However, a slight variation in the baseline resistance is observed for both printed gas sensors, which can be attributed to the adsorption of water molecules on the sensor surface. Water molecules tend to replace the initially adsorbed oxygen species, leading to the release of trapped electrons back into the conduction band of the metal oxide. This process reduces the sensor's resistance, as previously reported in the literature.^{45,46} The humidity effect is more pro-

Paper

nounced in SnO₂, as its optimum sensing performance is achieved at room temperature, whereas the In_2O_3 sensor requires an elevated operating temperature of approximately 100 °C for optimal response.³⁰ At room temperature, humidity has a greater impact on sensing due to the increased presence of physisorbed water molecules, which actively participate in the charge transfer process.⁴⁷ In contrast, at higher temperatures, water molecules tend to desorb more readily, reducing their influence on the sensor's electrical properties. This explains the stronger humidity dependence observed in SnO₂ compared to In_2O_3 . The superior selectivity for NO₂ is attributed to its higher electron affinity of 2.28 eV, compared to the lower electron affinity of pre-adsorbed oxygen at 0.43 eV and other gases.^{13,33}

Table 2 presents a comparison of recent studies on NO_2 sensing with the current work. The results clearly demonstrate that the inkjet-printed SnO_2 microsensor offers performance that is either comparable to or surpasses those of previously reported sensors.

Conclusions

The presented research study demonstrates the potential of inkjet-printed metal oxide gas sensors for highly sensitive NO₂ detection. The SnO₂ sensor exhibited excellent room-temperature performance, detecting NO₂ concentrations as low as 10 ppb, while the In₂O₃ sensor achieved optimal sensitivity at an elevated operating temperature of 100 °C. Both sensors showed a linear response to NO₂, ensuring reliable and reproducible measurements. Although humidity variations slightly influenced baseline resistance, the sensors maintained strong selectivity for NO₂ over other gases. These results underscore the viability of printed gas sensors for environmental monitoring applications, offering an efficient approach for air quality sensing.

Author contributions

P. K. Shihabudeen: conceptualization, methodology, investigation, data curation, writing – original draft preparation, and writing – review & editing. Shivam Gupta: investigation and writing – review & editing. Yu-Hsien Lin: methodology and investigation. Shih-Wen Chiu: methodology and writing – review & editing. Yu Ting Chuang: methodology and investigation. Yuan Fu Tang: methodology and investigation. Yuan Fu Tang: methodology and investigation. Nyan-Hwa Tai: resources and writing – review & editing. Kea-Tiong Tang: supervision, writing – review & editing, and funding acquisition.

Data availability

All the data will be provided and made available upon request.

Conflicts of interest

There are no conflicts to declare.

Acknowledgements

The authors acknowledge the National Science and Technology Council (NSTC), Taiwan, for financial support of the work (NSTC 113-2218-E-007-019, MOST 111-2221-E-007-108-MY3 and NSTC 113-2640-E-007-005).

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